

Sliver for SFF-TA-1002

TE Internal #: 2340331-1

TE Sliver, PCB Edge Card, Straddle Mount, 56 Position, Surface Mount, .6 mm [.023 in] Centerline, Sliver for SFF-TA-1002, Internal I

/O Connectors

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Connectors > PCB Connectors > Internal I/O Connectors











Internal I/O Connector Type: TE Sliver
Connector Mates With: PCB Edge Card
PCB Mount Orientation: Straddle Mount

Number of Positions: 56
Industry Standard: Gen-Z

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Internal I/O Connector Type	TE Sliver
Connector Mates With	PCB Edge Card

Configuration Features

Number of Rows	2
PCB Mount Orientation	Straddle Mount
Number of Positions	56

Contact Features

PCB Contact Termination Area Plating Material	Tin
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	1.1 A
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]



Termination Features

Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.6 mm[.023 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Industry Standard	Gen-Z

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on



requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

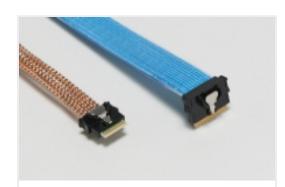




Also in the Series | Sliver for SFF-TA-1002





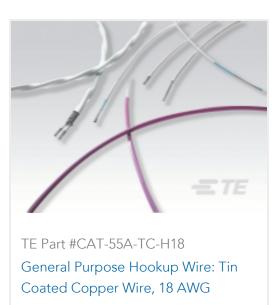


Internal I/O Cable Assemblies(105)



Internal I/O Connectors(133)

Customers Also Bought





















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2340331-1_C1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2340331-1_C1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2340331-1_C1.3d_stp.zip

English

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Product Specifications

Application Specification

English

Agency Approvals

UL Report

English